

PRODUCT/PROCESS CHANGE NOTICE (PCN)

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PCN #:	CN #: F0301-02 DA'		4/2/2003	MEANS OF DISTI	NGUISHING CHANGED DEVICES:	
Product Affe	ected:			□ Product Mark		
IDT72V2103	, IDT72V2113, IDT7	2V36100, IDT72	V36110	Back Mark	Please see Des	cription section below
IDT72V295,	IDT72V2105, IDT72	V2101, IDT72V2	2111	Date Code	for details	
Date Effectiv	ve: 7/2/2003			□ Other		
Contact:	Dasharath Patel					
Title:	Quality Assurance I	Manager		Attachment::	Yes	No No
Phone #:	(408) 330-1488					
Fax #:	(408) 330-1450			Samples: Avai	ilable now	
E-mail:	Dasharath.Patel@	lidt.com				
DESCRIPT	ON AND PURPOSI	E OF CHANGE:				
Die Tech				nrink and process char	nge from CEMOS	8 to CEMOS 11.5
Wafer Fa	brication Process					
□ Assembly				s of identifying mater		
Equipment	nt		CEM	1	Date Code:	
			CEM	OS 11.5: X-Step	Date Code:	XByyww
□ Testing □ Manufact	uring Site					yy: Year
Data She	-					ww: Work Week
\Box Other						ww. work week
IDT records to grant app it will be as IDT reserve	R ACKNOWLEDG indicate that you required and its additional or request additional or request additional that this changes the right to ship either version has been de	uire written notifi onal information e is acceptable. er version manufa	cation of this of this of the second se	not receive acknowled	lgement within 30	days of this notice
Customer:] Approval for	shipments pri	or to effective date.
Name/Date:			E-	Mail Address:		
Title:			Pł	none# /Fax# :		
CUSTOME	R COMMENTS:					
IDT ACKN	OWLEDGMENT O	F RECEIPT:				
RECD. BY:				DATE:		
IDT FRA-15	509-01 REV. 00 09/1	8/01	Page	1 of 3		Refer To QCA-1795



Integrated Device Technology, Inc. 2975 Stender Way, Santa Clara, CA - 95054

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ATTACHMENT - PCN #: F0301-02

PCN Type:	Die Shrink and Process Change
Data Sheet Change:	None
Detail of Change:	Die shrink and process technology change (CEMOS 8 to CEMOS 11.5) for the following products:
	IDT72V2103, IDT72V2113, IDT72V36100, IDT72V36110 IDT72V295, IDT72V2105, IDT72V2101, IDT72V2111

Conversion Schedule (Estimated)

Samples

Available upon request

7/2/2003

Production Shipments



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Qualification Plan: QFI-02-17

Test Vehicle:

IDT72V36110

Test Description/Condition	Test Methods	SS /# Fails	Test Results
Highly Accelerated Stress Test (HAST) (100 Hrs, @130°C/85%RH,Static Bias)	EIA/JESD22-A110	45/0	45 / 0
Temperature Cycling (-65°C to +150°C, 500 cyc)	MIL-STD-883, Method 1010	45/0	45 / 0
Auto Clave (SPP) (168Hrs, @ 2ATM, 121°C)	EIA/JESD22-A102	45/0	45 / 0
Life Test (+125°C, 1000 hrs)	MIL-STD-883, Method 1005	77/0	77 / 0
Latch-Up Immunity (+ - I and V stress, + - 100mA Trigger)	EIA/JESD 78	10/0	10 / 0
ESD Human Body Model	MIL-STD-883, Method 3015	9/0	9/0
ESD Charge Device Model	JESD22-C101	6/0	6 / 0

Characterization Data:

Characterization Data is available upon request.